e2V

e2v technologies

FEATURES

- 1024 by 256 Pixel Format
- 26 µm Square Pixels
- Image Area 26.6 x 6.7 mm
- Wide Dynamic Range
- Symmetrical Anti-static Gate Protection
- Open Electrode Structure for Enhanced Quantum Efficiency
- Advanced Inverted Mode Operation
- Anti-blooming Readout Register
- Zero Light Emitting Output Amplifier

APPLICATIONS

- Spectroscopy
- Scientific Imaging
- **TDI** Operation

INTRODUCTION

The open electrode CCD30-11 is a high performance CCD sensor designed as an upgrade for the standard CCD30-11, for use in the scientific spectroscopy instrument market, where enhanced quantum efficiency is required at near-ultraviolet wavelengths. With an array of 1024 x 256 26 μm square pixels it has an imaging area to suit most spectrometer outputs of 26.6 x 6.7 mm (1.05 x 0.26 inch).

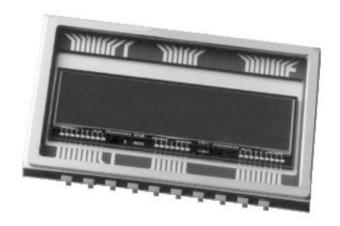
The readout register is organised along the long (1024 pixel) edge of the sensor and contains an anti-blooming drain to allow high speed binning operations of low level signals which may be adjacent to much stronger signals. The novel output amplifier design has no light emission.

Standard three phase clocking and buried channel charge transfer are employed and Inverted Mode Operation (IMO) is included as standard.

The open electrode CCD30-11 is packaged in a 20-pin DIL ceramic package and is pin compatible (but not completely clock compatible) with the standard CCD30-11.

Designers are advised to consult e2v technologies should they be considering using CCD sensors in abnormal environments or if they require customised packaging.

CCD30-11 Open Electrode **High Performance CCD Sensor**



TYPICAL PERFORMANCE

| Pixel readout frequency 20 - 1000 | кНz |
|--|----------------|
| Output amplifier sensitivity 1.5 μV_{ν} | e ⁻ |
| Peak signal | ixel |
| Dynamic range | |
| Spectral range 200 - 1060 | nm |
| Readout noise (at 140 K, 20 kHz) \cdot 4 \cdot e | rms |
| QE at 700 nm 50 | % |
| Peak output voltage 450 | mV |

GENERAL DATA

Format

| Image area | | | | | | 26.6×6.7 | mm |
|---------------|-----|--|--|--|--|-------------------|----|
| Active pixels | (H) | | | | | . 1024 | |
| | (V) | | | | | 256 | |
| Pixel size . | | | | | | . 26 x 26 | μm |

Package

| Package size | | | | | | | 32. | 89 : | × 20.0 | 7 mm |
|-------------------|--|--|--|----|------|-----|-------|------|--------|-------|
| Number of pins . | | | | | | | | | | 20 |
| Inter-pin spacing | | | | | | | | | 2.54 | 4 mm |
| Inter-row spacing | | | | | | | | | 15.24 | 4 mm |
| Window material | | | | αι | ıart | 7 (| or re | emo | ovable | alass |

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PERFORMANCE

| | Min | Typical | Max | |
|--|------|--------------------|------|---------------------------|
| Peak charge storage (see note 1) | 200k | 300k | - | e ⁻ /pixel |
| Peak output voltage (unbinned) | - | 450 | - | mV |
| Dark signal at 293 K (see note 2) | - | 250 | 500 | e ⁻ /pixel/s |
| Charge transfer efficiency (see note 3): parallel serial | | 99.9999 99.9993 | | % % |
| Output amplifier sensitivity | 1.3 | 1.8 | 2.3 | μV/e ⁻ |
| Readout noise at 140 K (see note 4) | - | 4 | 6 | rms e ⁻ /pixel |
| Readout frequency (see note 5) | - | 20 | 5000 | kHz |
| Response non-uniformity (std. deviation) | - | 3 | 10 | % of mean |
| Dark signal non-uniformity at 293 K (std. deviation) | - | 100 | 200 | e ⁻ /pixel/s |
| Output node capacity relative to image section | - | 4.0 | - | |

ELECTRICAL INTERFACE CHARACTERISTICS

Electrode capacitances (measured at mid-clock level):

| | Min | Typical | Max | |
|------------------|-----|---------|-----|----|
| IØ/IØ interphase | - | 2.0 | - | nF |
| RØ/RØ interphase | - | 70 | - | pF |
| IØ/SS | - | 11 | - | nF |
| RØ/SS | - | 185 | - | pF |
| Output impedance | - | 300 | - | Ω |

NOTES

- 1. Signal level at which resolution begins to degrade.
- 2. The typical average (background) dark signal at any temperature T (kelvin) between 230 and 300 K is given by:

$$Q_d/Q_{d0} = 1.14 \times 10^6 T^3 e^{-9080/T}$$

where Q_{d0} is the dark current at 293 K. Note that this is typical performance and some variation may be seen between devices. Below 230 K additional dark current components with a weaker temperature dependence may become significant.

- 3. CCD characterisation measurements made using charge generated by X-ray photons of known energy.
- 4. Measured using a dual-slope integrator technique (i.e. correlated double sampling) with a 10 μ s integration period.
- 5. Readout above 5000 kHz can be achieved but performance to the parameters given cannot be guaranteed.

BLEMISH SPECIFICATION

Traps Pixels where charge is temporarily held.

Traps are counted if they have a capacity greater than 200 e⁻ at 233 K.

Slipped columns Are counted if they have an amplitude

greater than 200 e⁻.

of less than 90% of the local mean signal illuminated at approximately half saturation.

White spots

Are counted when they have a generation rate 100 times the specified maximum dark signal generation rate at 293 K (measured between 233 and 273 K). The typical temperature dependence of white spot blemishes is different from that of the average dark signal and is given by:

$$Q_d/Q_{d0} = 122T^3e^{-6400/T}$$

White column A column which contains at least 9 white

defects.

Black column A column which contains at least 9 black

defects.

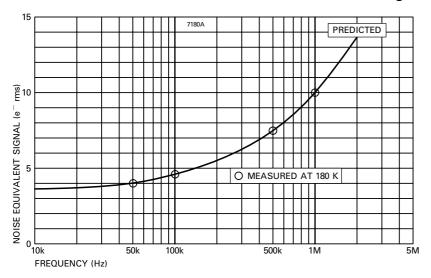
| GRADE | 0 | 1 | 2 |
|-------------------------------------|----|----|----|
| Column defects: black or slipped | 0 | 1 | 6 |
| white | 0 | 0 | 0 |
| Black spots: <3 pixels | 2 | 3 | 15 |
| <5 pixels | 1 | 2 | 8 |
| <10 pixels | 0 | 0 | 1 |
| >10 pixels | 0 | 0 | 0 |
| Traps > 200 e- | 1 | 2 | 5 |
| White spots | 10 | 10 | 15 |

Minimum separation between

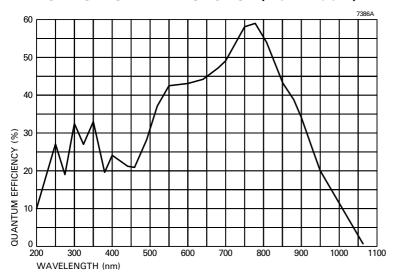
adjacent black columns 50 pixels

Note The effect of temperature on defects is that traps will be observed less at higher temperatures but more may appear below 233 K. The amplitude of white spots and columns will decrease rapidly with temperature.

TYPICAL OUTPUT CIRCUIT NOISE (Measured using clamp and sample)



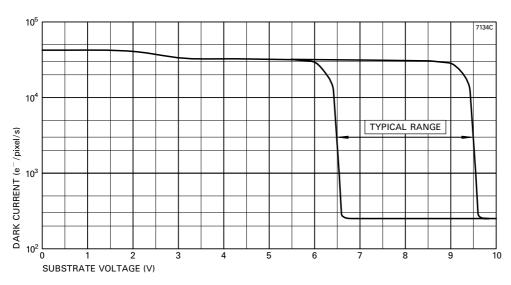
TYPICAL SPECTRAL RESPONSE (No window)



Note

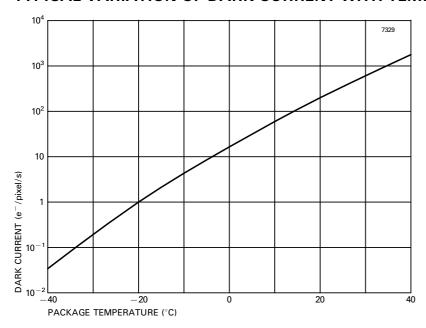
UV QE varies rapidly with wavelength over the 200 to 400 nm range due to the thick AR coating.

TYPICAL VARIATION OF DARK SIGNAL WITH SUBSTRATE VOLTAGE

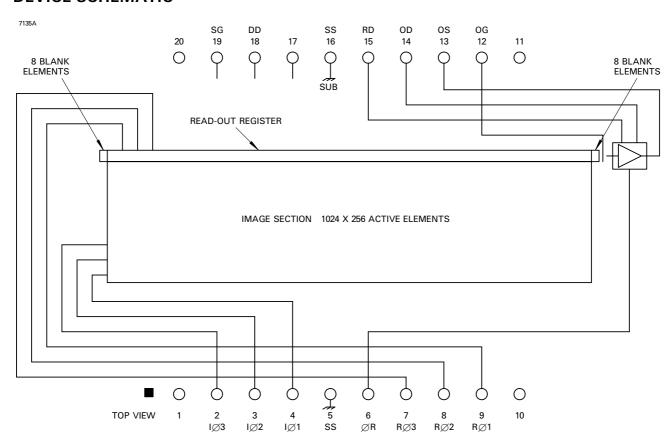


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TYPICAL VARIATION OF DARK CURRENT WITH TEMPERATURE



DEVICE SCHEMATIC



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CONNECTIONS, TYPICAL VOLTAGES AND ABSOLUTE MAXIMUM RATINGS

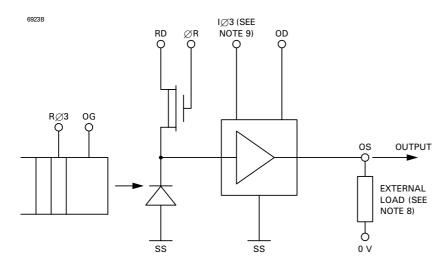
| | | | | E AMPLITU | MAXIMUM RATINGS | |
|-----|-----|---|-----|------------|----------------------|---------------------------------|
| PIN | REF | DESCRIPTION | Min | Typical | Max | with respect to V_{SS} |
| 1 | - | No connection | | - | | - |
| 2 | IØ3 | Image section, phase 3 (clock pulse) | 10 | 12 | 15 | <u>+</u> 20 V |
| 3 | IØ2 | Image section, phase 2 (clock pulse) | 10 | 12 | 15 | <u>+</u> 20 V |
| 4 | IØ1 | Image section, phase 1 (clock pulse) | 10 | 12 | 15 | <u>+</u> 20 V |
| 5 | SS | Substrate | 8 | 9.5 | 11 | - |
| 6 | ØR | Output reset pulse | 10 | 12 | 15 | <u>+</u> 20 V |
| 7 | RØ3 | Readout register, phase 3 (clock pulse) | 10 | 12 | 15 | <u>+</u> 20 V |
| 8 | RØ2 | Readout register, phase 2 (clock pulse) | 10 | 12 | 15 | <u>+</u> 20 V |
| 9 | RØ1 | Readout register, phase 1 (clock pulse) | 10 | 12 | 15 | <u>+</u> 20 V |
| 10 | - | No connection | | see note 7 | 7 | - |
| 11 | - | No connection | | see note 7 | 7 | - |
| 12 | OG | Output gate | 2 | 3.5 | 5 | <u>+</u> 20 V |
| 13 | OS | Output transistor source | | see note 8 | 3 | -0.3 to +25 V |
| 14 | OD | Output drain | 27 | 29 | 31 | -0.3 to +25 V |
| 15 | RD | Reset transistor drain | 17 | 18 | 19 | -0.3 to +25 V |
| 16 | SS | Substrate | 8 | 9.5 | 11 | -0.3 to +25 V |
| 17 | - | No connection | | _ | | |
| 18 | DD | Diode drain | 20 | 22 | 25 | -0.3 to +25 V |
| 19 | SG | Spare gates | 0 | 0 | V _{SS} + 19 | <u>+</u> 20 V |
| 20 | - | No connection | | - | | - |

If all voltages are set to the 'typical' values, operation at or close to specification should be obtained. Some adjustment within the minimum - maximum range specified may be required to optimise performance.

Voltage between pairs of pins: OS to OD \pm 15 V.

Maximum current through any source or drain pin: 10 mA.

OUTPUT CIRCUIT

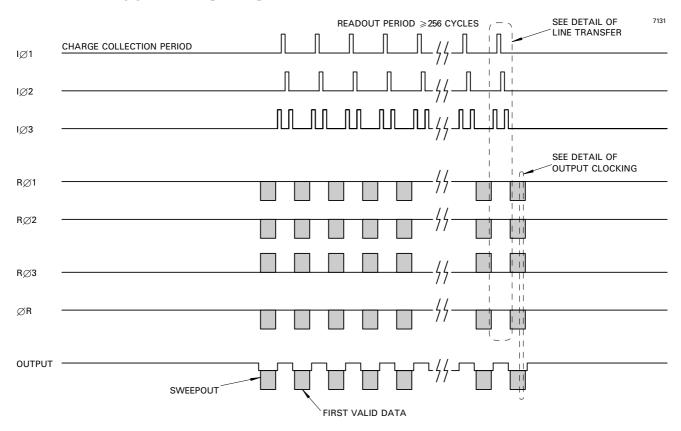


NOTES

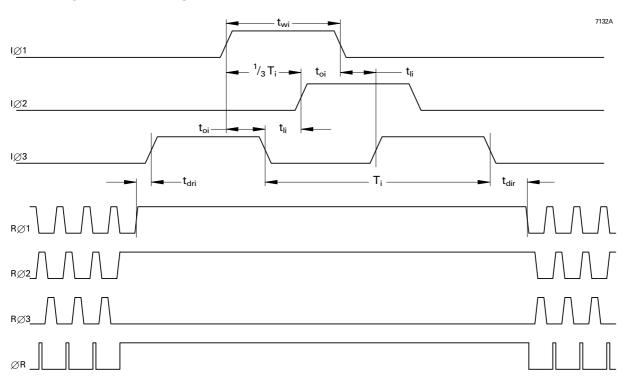
- 6. All pulse low levels 0 \pm 0.5 V.
- 7. There is no access to the temperature sensing diodes in the back-thinned version of the CCD30-11.
- 8. Not critical; can be a 1 5 mA constant current source, or 5 10 $k\Omega$ resistor.
- 9. The amplifier has a DC restoration circuit, which is activated internally whenever IØ3 is pulsed high.

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FRAME READOUT TIMING DIAGRAM



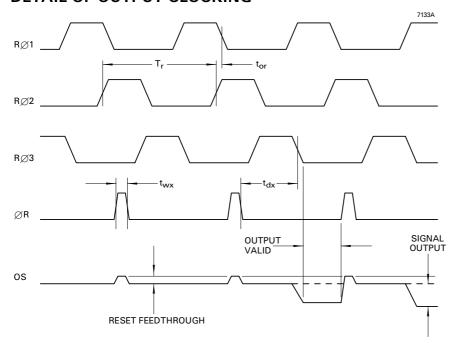
DETAIL OF LINE TRANSFER



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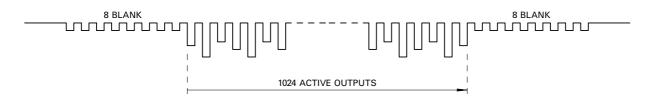
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DETAIL OF OUTPUT CLOCKING



LINE OUTPUT FORMAT

7130A



CLOCK TIMING REQUIREMENTS

| Symbol | Description | Min | Typical | Max | |
|---------------------|---|-----------------|--------------------|--------------------|----|
| T _i | Image clock period | 50 | 90 | see note 10 | μs |
| t _{wi} | Image clock pulse width | 25 | 45 | see note 10 | μs |
| t _{ri} | Image clock pulse rise time (10 to 90%) | 5 | 20 | 0.5t _{oi} | μs |
| t _{fi} | Image clock pulse fall time (10 to 90%) | t _{ri} | 20 | 0.5t _{oi} | μs |
| t _{oi} | lmage clock pulse overlap | 3 | 10 | 0.2T _i | μs |
| t _{li} | Image clock pulse, two phase low | 2 | 10 | 0.2T _i | μs |
| t _{dir} | Delay time, IØ stop to RØ start | 3 | 10 | see note 10 | μs |
| t _{dri} | Delay time, R∅ stop to I∅ start | 1 | 2 | see note 10 | μs |
| T _r | Output register clock cycle period | 200 | see note 11 | see note 10 | ns |
| t _{rr} | Clock pulse rise time (10 to 90%) | 50 | 0.1T _r | 0.3T _r | ns |
| t _{fr} | Clock pulse fall time (10 to 90%) | t _{rr} | 0.1T _r | 0.3T _r | ns |
| t _{or} | Clock pulse overlap | 20 | 0.5t _{rr} | 0.1T _r | ns |
| t _{wx} | Reset pulse width | 30 | 0.1T _r | 0.2T _r | ns |
| t_{rx} , t_{fx} | Reset pulse rise and fall times | 20 | 0.5t _{rr} | 0.2T _r | ns |
| t _{dx} | Delay time, ØR low to RØ3 low | 30 | 0.5T _r | 0.8T _r | ns |

NOTES

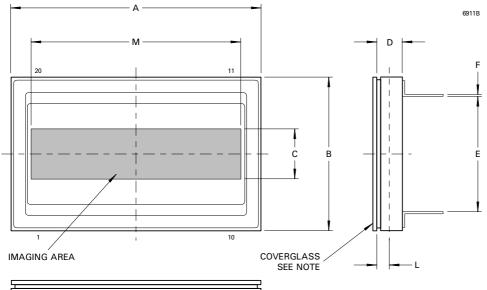
10. No maximum other than that necessary to achieve an acceptable dark signal at the longer readout times.

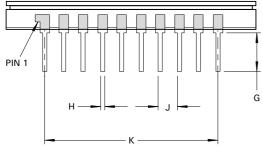
11. As set by the readout period.

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OUTLINE

(All dimensions without limits are nominal)





Outline Note

The device is normally supplied with a temporary glass window for protection purposes. It can also be supplied with a fixed, quartz or fibre-optic window where required.

| Ref | Millimetres |
|-----|----------------------------|
| A | 32.89 ± 0.38 |
| В | 20.07 ± 0.25 |
| С | 6.7 |
| D | 3.30 ± 0.33 |
| Е | 15.24 ± 0.25 |
| F | $0.254 + 0.051 \\ - 0.025$ |
| G | 5.21 |
| Н | 0.46 ± 0.05 |
| J | 2.54 ± 0.13 |
| K | 22.86 ± 0.13 |
| L | 1.65 ± 0.56 |
| М | 26.6 |
| | |

ORDERING INFORMATION

Options include:

- Temporary Quartz Window
- Permanent Quartz Window
- Temporary Glass Window

For further information on the performance of these and other options, please contact e2v technologies.

HANDLING CCD SENSORS

CCD sensors, in common with most high performance MOS IC devices, are static sensitive. In certain cases a discharge of static electricity may destroy or irreversibly degrade the device. Accordingly, full antistatic handling precautions should be taken whenever using a CCD sensor or module. These include:-

- Working at a fully grounded workbench
- Operator wearing a grounded wrist strap
- All receiving socket pins to be positively grounded
- Unattended CCDs should not be left out of their conducting foam or socket.

Evidence of incorrect handling will invalidate the warranty. All devices are provided with internal protection circuits to the gate electrodes (pins 2, 3, 4, 6, 7, 8, 9, 12, 19) but not to the other pins.

HIGH ENERGY RADIATION

Device parameters may begin to change if subject to an ionising dose of greater than 10^4 rads.

Certain characterisation data are held at e2v technologies. Users planning to use CCDs in a high radiation environment are advised to contact e2v technologies.

TEMPERATURE LIMITS

| | Min | Typical | Max | | | | | |
|--|-----|---------|-----|---|--|--|--|--|
| Storage | 73 | - | 373 | K | | | | |
| Operating | 73 | 233 | 323 | K | | | | |
| Operation or storage in humid conditions may give rise to ice on | | | | | | | | |
| the sensor surface, causing irreversible damage. | | | | | | | | |
| Device heating/cooling 5 K/min max | | | | | | | | |

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